## **Product / Process Change Notification**



### N° 2017-059-A

Dear Customer,

Please find attached our INFINEON Technologies PCN:

## Introduction of an Additional Wafer Test Location in Kulim, Malaysia Affecting Several Products

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 13. April 2018.
- Infineon aligns with the widely-recognized JEDEC STANDARD "JESD46", which stipulates: "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change."

Your prompt reply will help Infineon Technologies to assure a smooth and well executed transition. If Infineon does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.

Infineon Technologies AG Postal Address Headquarters: Am Campeon 1-15, D-85579 Neubiberg, Phone +49 (0)89 234-0 Chairman of the Supervisory Board: Dr. Eckart Sünner Management Board: Dr. Reinhard Ploss (CEO), Dominik Asam, Dr. Helmut Gassel, Jochen Hanebeck Registered Office: Neubiberg Commercial Register Amtsgericht München HRB 126492

2018-03-02

# Product / Process Change Notification



### N° 2017-059-A

► **Products affected:** Please refer to affected product list 1\_cip17059\_a

#### Detailed Change Information:

Subject:	Introduction of an additional wafer test location in Kulim, Malaysia affecting several products		
Reason:	Expansion of wafer test capacity. Due to continuously raising demand for Infineon automotive products we have to implement the well-known front end (FE) Kulim (Malaysia) as an additional wafer test location.		
Description:	<u>Old</u>	New	
	<ul> <li>Infineon Technologies Austria AG, Villach, Austria</li> </ul>	<ul> <li>Infineon Technologies (Kulim) Sdn. Bhd, Kulim, Malaysia or</li> <li>Infineon Technologies Austria AG, Villach, Austria</li> </ul>	
Product Identification:	Traceability is ensured by lotnumber.		
Impact of Change:	No change in form fit or function and no impact on quality and reliability of the final product. The wafer test location verification is performed via the Advanced Measurement System Analysis (AMSA) methodology.		
Attachments:	1_cip17059_a Affected product list		
Time Schedule:			
Final qualification report:	available		
First samples available:	N.A.		
Intended start of delivery:	01-September-2018		

If you have any questions, please do not hesitate to contact your local Sales office.

PCN N<sup>o</sup> 2017-059-A

Introduction of an Additional Wafer Test Location in Kulim, Malaysia Affecting Several Products

infineon

Sales name	SP number	OPN	Package
BSP742RI	SP000278925	BSP742RIXUMA1	PG-DSO-8-24
BTS3408G	SP001027114	BTS3408GXUMA2	PG-DSO-8-36
BTS6163D	SP000264201	BTS6163DAUMA1	PG-TO252-5-11